

FIVE WAYS TO USE

Solder Preforms

1. **Component attach**
2. **Thermal interface materials**
3. **Seals – cryogenic, hermetic, and vacuum**
4. **Thermal fuses**
5. **Solder Fortification®**

Reduce Costs/Improve Quality

- Higher precision and volume control
- Improved reliability
- Lower voiding
- Controlled bondline thickness
- Can be flux-coated
- Tape & reel packaging available

Contact our engineers today:

askus@indium.com

Learn more: www.indium.com

ISO 9001
REGISTERED

Form No. 98614 R3
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